

Calibration des Microroc (II)

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- 2 Comparison single chip & ASU chip
- 3 Chip to chip variations
- 4 Outlook

Previous results (I)

Experimental conditions

- Test charge: 2.5, 12.5, 25, 37.5 fC
- Pedestal offset at 7
- Send charge to group of 8 channels

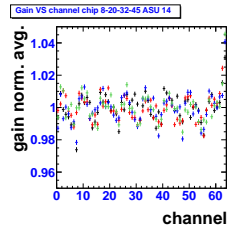
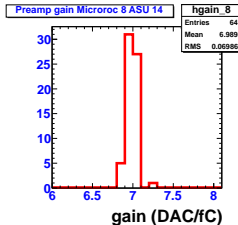
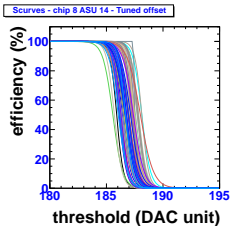
Pedestal offset

- Reduction of pedestal RMS by factor 2

Preamplifier gain (4 chips)

- ~ 7 DAC/fC with 1 % RMS variations
- (Small) channel to channel variations
- Noise of about 0.12 fC

Previous results (II)



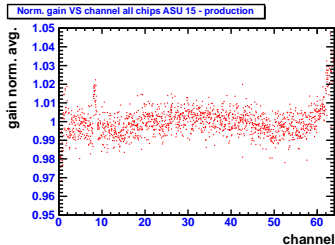
Conditions for next tests

- Test charge: 2.5, 12.5, 22.5, 32.5 fC
- Pedestal offset at 7
- Send charge to single channels

Comparison single chip & ASU chip

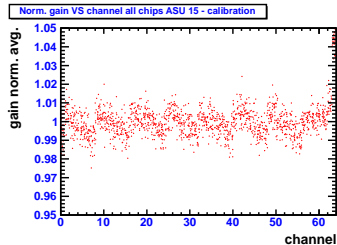
Production test

- Flat pattern
- Wrong gain channel 8
- Higher gain channel 62 & 63



Recent ASU test

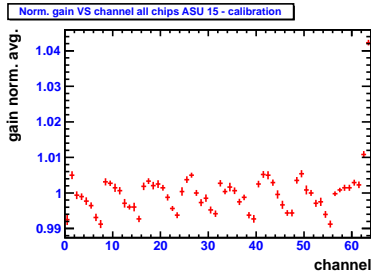
- Periodic pattern
- Variations modulo 8
- Higher gain channel 63



Channel to channel variations

Mean gain versus channel number

- Periodic pattern observed for all fully tested ASUs (14, 15)
- Reflect length variation of PCB pad to pin lines
- Channels 62 and mostly 63 are clearly far from average



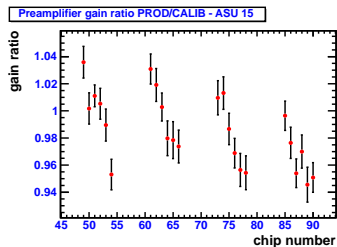
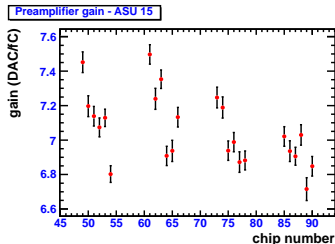
Chip to chip variations

Position on ASU

- Gain drops along rows
- 10 % var. between row 1–6
- Seen for ASU 14 & 15 so far

Ratio ASU chip/single chip

- Normalise measured gain to production gains
- → attenuation of test Q



Outlook

- MICROROCs show great performance:
Low noise (0.12 fC) and gain variations of 1 % RMS
- Channel to channel and chip to chip variations understood as PCB lines variations and attenuation of test signal from interDIF to chips
- Offset map available for all ASUs
- Next steps:
Complete gain map of all ASU (all data reconstructed)
Calibration with Bulk mesh Send jobs on MUST